HP ElitePOS G1 Retail System, Models 141, 143, & 145

FRONT VIEW



- 14-inch diagonal display panel (wide-aspect ratio); FHD
 1920 x 1080 resolution Projected Capacitive Touch Screen
- 2. HP ElitePOS Integrated Column Printer
- 3. Choice of 2 ElitePOS I/O Connectivity Bases
- 4. HP ElitePOS Integrated MSR
- 5. Recessed Power Button

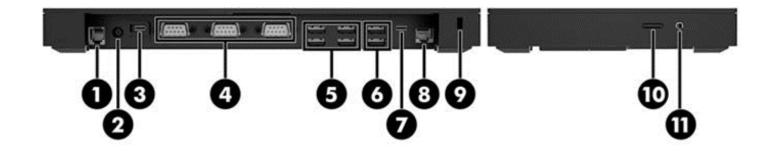
REAR VIEW



REAR VIEW

- 1. HP ElitePOS Top Mount 2x20 Customer-facing Display (CFD) 3. Choice of 2 ElitePOS I/O Connectivity Bases
- 2. Rotate/Tilt Stand (Fixed Position Stand Available)

HP ElitePOS Basic I/O Connectivity Base (Rear/Side View)



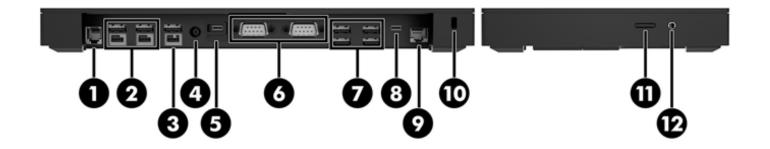
Basic I/O Connectivity Base components

- 1. Cash drawer jack
- 2. Power connector
- 3. USB Type-C power port
- 4. Powered serial ports (3)
- 5. USB 2.0 ports (4)
- 6. USB 3.0 ports (2)

- 7. USB Type-C port
- 8. RJ-45 network jack
- 9. Security cable slot
- 10. MicroSD card reader
- 11. Headset jack

IMPORTANT: To avoid damage to the computer, DO NOT plug a telephone cable into the cash drawer jack.

Advanced I/O Connectivity Base* (Rear/Side View)



Advanced I/O Connectivity Base components

- 1. Cash drawer jack
- 2. Powered USB 12 V ports (2)
- 3. Powered USB 24 V port
- 4. Power connector
- 5. USB Type-C power port
- 6. Powered serial ports (2)

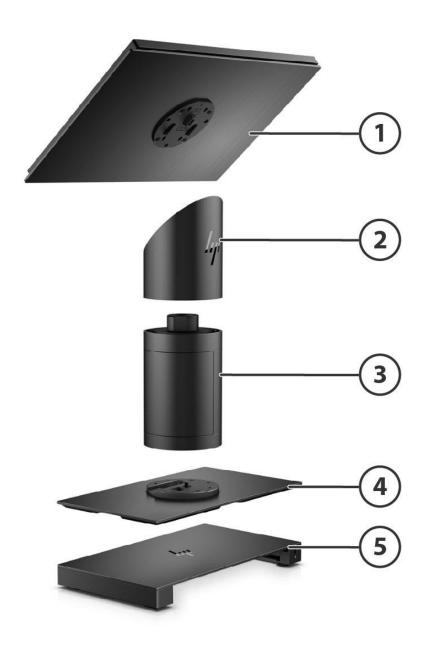
- 7. USB 3.0 ports (4)
- 8. USB Type-C port
- 9. RJ-45 network jack
- 10. Security cable slot
- 11. MicroSD card reader
- 12. Headset jack

IMPORTANT: To avoid damage to the computer, DO NOT plug a telephone cable into the cash drawer jack.

* Available November 2017

Overview

Component Breakdown



Component Breakdown

- 1. Head unit: Choice of Model 141 (Intel® Celeron® 3965U), 143 (Intel® Core™ i3 7100U)* or 145 (Intel® i5 -7300U)*
- 2. Fixed Position or Swivel & Tilt stand or No Stand Option
- 3. Optional Integrated Printer or Stand Spacer

- 4. Stability Base Plate
- 5. Connectivity Base: 2 Options based on I/O requirements



Not shown: Stand connects through a Single USB-C Cable with secure latching to connectivity base (Refer to page xxx) * Available November 2017

Stand Options Stand Options

- 1. HP ElitePOS Rotate/Tilt Stand with Integrated Column Printer 3. HP ElitePOS Fixed Position Stand
- 2. HP ElitePOS Rotate/Tilt Stand

NOTE: The stands are shown on a Stability Base Plate.

Stand Configurations



HP ElitePOS No Stand Option - Display Head Only (Includes 100mm VESA Mounting Bracket)



HP ElitePOS Fixed Position Stand with Stability Base Plate



HP ElitePOS Fixed Position Stand Counter Mount -No Base Plate-includes Counter Mounting Bracket

Overview



HP ElitePOS Rotate/Tilt Stand with Stability Base Plate



HP ElitePOS Rotate/Tilt Counter Mount No Base Plate/includes Counter Mounting Bracket



HP ElitePOS Rotate/Tilt Stand with Integrated Printer and Stability Base Plate



HP ElitePOS Rotate/Tilt Stand with Integrated Printer and No Base Plate-includes counter mount

NOTE: The mounting bracket requires an 80 mm hole in the countertop. The thickness of the countertop must be 10mm to 50 mm.



At A Glance

- Align Model to preferred solution
 - Model 141: Anti-glare WLED SVA 300-nit panel with FHD 1920 x 1080 resolution and an Intel® Celeron® 3965U
 2.2GHz 2M 2133 2C6 processor
 - Model 143: Anti-glare WLED UWVA 500-nit panel with FHD 1920 x 1080 resolution and an Intel® Core™ i3 7100U 2.40GHz 3M 2133 2C6 processor*
 - Model 145: Anti-glare WLED UWVA 500-nit panel with FHD 1920 x 1080 resolution and an Intel[®] i5 -7300U
 2.60GHZ 3MB 2133 2C6 processor*
- Long lifecycle performance All-in-One (AiO) Retail System for retail and hospitality markets Choice of operator display:
 - 14"diagonal Wide Aspect ratio Projected Capacitive display; Full HD SVA 1920 x 1080 Resolution, Anti-qlare
 - 14"diagonal Wide Aspect ratio Projected Capacitive display; Full HD UWVA 1920 x 1080 Resolution, Anti-glare*
- Processor choices:
 - Intel® Core™ i5-7300U with vPro (2.6GHz, 3M Cache, 2 Cores)*
 - o Intel® Core™ i3-7100U (2.4GHz 3M Cache, 2 Cores)*
 - o Intel® Core™ Celeron® 3965U (2.2GHz, 2M Cache, 2 Cores)
- Operating System choices:
 - Windows 10 Professional 64-bit
 - o Windows 10 IoT Enterprise 2016 LTSB 64-bit
 - o FreeDOS 2.0
- Connectivity Base Choices
 - HP Basic I/O Connectivity Base
 - HP Advanced I/O Connectivity Base*
- Integrated peripheral options (can also be purchased and installed separately except for the HP ElitePOS MSR & HP ElitePOS Column Printer which are configurable options):
 - o HP ElitePOS MSR
 - o HP ElitePOS Column Printer
 - o HP ElitePOS Fingerprint Reader
 - HP ElitePOS Top Mount 2x20 CFD
- Industry-standard 100mm VESA mounting pattern allows for flexible use without the optional stand (Mounting hardware sold separately)
- Choice of Fixed Position Stand, Rotate/Tilt Stand that allows for 10° angle adjustability & 180-degree rotation left or right, or no stand (display – head unit only) which includes 100mm VESA Mounting Bracket
- (2) Two DDR4 Memory Slots (32 GB Maximum)
- Realtek RTL8153 Ethernet Connection
- Intel & Realtek WLAN Options
- Trusted Platform Module (TPM 2.0)
- HP BIOSphere with HP Sure Start technology
- (1) M.2 drive bay
- Cable Management Features
- ENERGY STAR® certified, EU Compliant, RoHS2 Compliant, EPEAT® Gold
- Basic Retail I/O connectivity Base: 120W, 88% efficient, active PFC (external)
- Advanced Retail I/O connectivity Base: 180W, 89% efficient, active PFC (external)
- Display Head unit Only 65W, 89% efficient at 20V, active PFC (external)
- Standard Warranty Options 90/90/90, 1/1/1, 3/3/3; Plus Optional Care Packs

* Available November 2017

NOTE: See important legal disclosures for all listed specs in their respective features sections.



Standard and Configurable Components

OPERATING SYSTEM

Preinstalled Windows 10 Professional 64-bit

Windows 10 IoT Enterprise 2016 LTSB 64-bit

FreeDOS 2.0

Certified SuSE Linux® 12 SP3**

NOTE: In accordance with Microsoft's support policy, HP does not support the Windows 8 or Windows 7 operating system on products configured with Intel® 7th generation and forward processors or provide any Windows 8 or Windows 7 drivers on http://www.support.hp.com

* Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See http://www.microsoft.com

** SUSE YES Certification is planned for late CY17 on a single platform configuration. More information about SUSE YES certification on https://www.suse.com/partners/ihv/yes/

The following features are not supported by SUSE Linux Enterprise Desktop:

- Power Management features
- Multi-touch capabilities
- Systems configured with Linux do not qualify for ENERGY STAR

PROCESSORS

Model 143 & 145***

- Intel® Core™ i5-7300U with vPro (2.6GHz, 3M Cache, 2 Cores)
- Intel[®] Core[™] i3-7100U (2.4GHz 3M Cache, 2 Cores)

Model 141

Intel® Core™ Celeron® 3965U (2.2GHz, 2M Cache, 2 Cores)

NOTE: Core[™] i5 Turbo Boost technology – performance can be increased through the BIOS

*NOTE: In accordance with Microsoft's support policy, HP does not support the Windows 8 or Windows 7 operating system on products configured with Intel® 7th generation and forward processors or provide any Windows 8 or Windows 7 drivers on http://www.support.hp.com

**Note: Multi-Core is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. 64-bit computing system required. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering is not a measurement of higher performance.

***Available November 2017



Standard and Configurable Components

CORE™ vPRO™ PROCESSORS

INTEL® 7th GENERATION CORE™ vPRO™ PROCESSORS

The HP ElitePOS Retail System features this technology, and includes processors that are part of the Intel® Stable Image. Platform Program (SIPP) designed to ensure the stability promise inherent in the value proposition of the HP ElitePOS Retail System. This makes these models the most stable, secure, and manageable platforms available to retailers today.

Intel® Advanced Management Technology (AMT) v11.6+ – An advanced set of remote management features and functionality which provides network administrators the latest and most effective tools to remotely discover, heal, and protect networked client systems regardless of the system's health or power state. AMT 11.6+ includes the following advanced management functions:

- Power Management (on, off, reset)
- Hardware Inventory (includes BIOS and firmware revisions
- Hardware Alerting
- Agent Presence
- System Defense Filters
- SOL/USBR
- Cisco NAC/SDN Support
- ME Wake-on-LAN
- DASH 1.1 compliance
- IPv6 Support
- Fast Call for Help a client inside or outside the firewall may initiate a call for help via BIOS screen, periodic connections, or alert triggered connection
- Remote Scheduled Maintenance pre-schedule when the PC connects to the IT or service provider console
 for maintenance. Remote PCs can get required patches, be inventoried, etc. by connecting to their IT console or
 Service Provider when it's convenient.
- Remote Alerts automatically alert IT or service provider if issues arise
- Access Monitor Provides oversight into Intel® AMT actions to support security requirements
- PC Alarm Clock
- Microsoft NAP Support
- · Host-based set-up and configuration
- Management Engine (ME) firmware roll back
- Wireless AMT functionality on Desktop (WoDT)
- Enhanced KVM resolution

*Some functionality of this technology, such as Intel Active management technology and Intel Virtualization technology, requires additional 3rd party software in order to run. Availability of future "virtual appliances" applications for Intel vPro™ technology is dependent on 3rd party software providers. Compatibility with future "virtual appliances" is yet to be determined.

** Intel® Active Management Technology requires an Intel® AMT-enabled chipset, network hardware and software, as well as connection with a power source and a corporate network connection. Setup requires configuration by the purchaser and may require scripting with the management console or further integration into existing security frameworks to enable certain functionality. It may also require modifications of implementation of new business processes.

CHIPSET

Intel® Multi-Chip Package – MCP



Standard and Configurable Components

HP BIOS

Key features of the HP BIOS include:

- Deployment and manageability HP BIOS provides several technologies that help integrate the HP ElitePOS G1
 Retail System into a business environment, such as PXE, remote configuration, remote control, and F10 Setup
 support for 14 languages.
- Update your BIOS via the cloud or standardize on a BIOS version hosted on Enterprise network.
- Select models feature either Intel® Standard Manageability or Intel® Core™ vPro™ Processor Technology.
- Stability HP BIOS supports the HP stable product roadmap by releasing only critical BIOS changes to the factory and advanced change notification.
- UEFI specification 2.5
- Absolute Persistence agent For tracking and tracing services, available in select countries, separate software and purchase of a subscription is required.
- Thermal and power management The HP BIOS provides and enables thermal and power management technologies so component temperatures are managed for high reliability and to assist in operating the ElitePOS G1 Retail System in any retail environment.
- Acoustic performance Industry leading acoustic emissions across the range of operating conditions.
- Serviceability HP BIOS provides diagnostic and detailed service information.
- Upgrades and recovery HP BIOS provides numerous ways to update the HP ElitePOS, using a host-based Windows application, various remote deployment tools (HP Client Manager, HP Software Support Manager, scheduled network updates, and fail-safe recovery. In addition, the HP ElitePOS system supports management tools for replicating BIOS settings throughout the Enterprise, either host-based software (HP BIOS Configuration Utility), 3rd party remote management tools such as SCCM, or manually using USB.
- HP BIOS uses PKI signing of the BIOS for trusted BIOS upgrades and recovery.

Additional HP BIOS Features:

- Power-On password Helps prevent an unauthorized user from powering on the system.
- Administrator password Also known as the setup password, this helps prevent unauthorized changes to the system configuration. If the administrator password is not known, the BIOS version cannot be changed and changes cannot be made to BIOS settings using F10 setup or under the OS.
- Advanced Configuration and Power Interface (ACPI) Represents a significant innovation in power and
 configuration management, allowing operating systems and applications to manage power based on activity and
 usage. The HP ElitePOS G1 Retail System uses ACPI to provide power conservation features.
- S5 Max Power Savings setting supports EU Lot6 requirement and allows the computer to power down below .5W
 in S5 (when turned off). When S5 Max Power Savings feature is enabled power to slots is turned off along with
 WOL functionality and USB Charging ports.
- When the S5 Maximum Power Savings feature is enabled, only the power button will turn on the system. Other wake sources such as Wake on LAN are powered off and do not function.

Sure Start

- BIOS Integrity checking Sure Start protection ensures that only trusted BIOS code is executed and not rootkits, viruses and malware. Verification is done upon boot up, shutdown and while on.
- Sure Start is set by default to automatically repair the BIOS if corrupted or compromised but is policy driven for better manageability.
- Protecting beyond BIOS Integrity checking and repair is extended to other data that should be protected such as network configuration parameters (network name), platform specific information (i.e. system IDs) and other code the system needs to boot.
- Audit enabled System Audit via Sure Start Event Logs capture data such as incident, repair date and time for troubleshooting and investigating.



Standard and Configurable Components

Security

- HP ElitePOS Biometric Fingerprint Reader (optional)
- Bolt to counter mechanism
- VESA mounting
- HP ElitePOS Keyed Cable Lock
- HP BIOSphere with SureStart Gen 3
- Device Guard
- Credential Guard and password protection
- Trusted Platform Module TPM 2.0 Embedded Security Chip (SLB9670 Common Criteria EAL4+ Certified)
- Drive lock
- USB enable/disable (via BIOS)
- Power-on password (via BIOS)
- Setup password (via BIOS)
- Tamper Resistant Screw affixed on stand of the system unit, used to secure display head to stand without Quick Release

NOTE: BIOS supports configuration on ports for the ElitePOS Basic I/O Connectivity Base and ElitePOS Advanced I/O Connectivity Base. The functionality is not supported with other products.



Standard and Configurable Components

SOFTWARE

HP Client Management Solutions (available for free download from hp.com/go/easydeploy)

HP BIOSphere with Sure Start Generation 3.0

HP Support Assistant

Device Guard

Credential Guard

GRAPHICS

Intel® HD Graphics (integrated)

Integrated Graphics Intel Integrated HD Graphics 610 (Celeron, Model 141); Intel Integrated HD Graphics 620 (Core

i3, Model 143, Core i5, Model 145)

DisplayPort Multimode capable; supports HDCP, Display Port Audio (2 streams), HBR2 link rates and Multi-

Stream Technology for a maximum of 3 displays (including the integrated panel)

Memory The BIOS has options for selecting the dedicated memory size of 128MB, 256MB or 512MB

Additional memory is allocated for graphics as needed using Intel's Dynamic Video Memory Technology (DVMT), to provide an optimal balance between graphics and system memory use.

Maximum Graphics Memory

Windows 10

>4 GB

Note: the actual amount of maximum graphics memory can be less than the amounts listed above depending upon your computer's configuration.

Maximum Color Depth

Graphics/Video API Support

32 bits/pixel

7th Generation Core™ processors:

- Next Generation Intel[®] Clear Video Technology HD Support is a collection of video playback and enhancement features that improve the end user's viewing experience
 - Encode/transcode HD content
 - Playback of high definition content including Blu-ray Disc
 - Superior image quality with sharper, more colorful images
- DirectX Video Acceleration (DXVA) support for accelerating video processing
 - o Full AVC/VC1/MPEG2/HEVC HW Decode
- Advanced Scheduler 2.0, 1.0
- Windows 10, Linux OS Support
- DirectX 12.1
- OpenGL 4.4
- Open CL 1.2 (Intel® HD Graphics 510)
- Open CL 1.2/2.0 (Intel® HD Graphics 530)



Standard and Configurable Components

Supported Display Resolutions and Refresh Rates

Note: Other resolutions may be available but are not recommended as they may not have been tested and qualified by HP

Resolution	Refresh Rate
640x480	60 Hz
800x600	60 Hz
1024x768	60 Hz
1280x720	60 Hz
1280x768	60 Hz
1360x768	60 Hz
1280x1024	60 Hz
1400x1050	60 Hz
1680x1050	60 Hz
1920x1080	60 Hz
1920x1200*	60 Hz
2048x1152*	60 Hz
2048x1280*	60 Hz
2048x1536*	60 Hz
2304x1440*	60 Hz
2560x1440*	60 Hz
3840x2160**	30 Hz
2560x1600*	60 Hz
2880x1800*	60 Hz
3200x2400*	60 Hz
4096x2160*	60 Hz
4096x2304*	60 Hz

^{*} Only supported on displays connected to the external DisplayPort connector.

^{** 3840}x2160 is not supported for Celeron series processors

Standard and Configurable Components

MEMORY

Туре

DDR4-2400 Memory DIMMs, Transfer rates up to 2400 MT/s

Maximum

32 GB

of Slots

2 SODIMM

Memory Upgrades

Both slots are customer accessible / upgradeable.

- 4 GB (4 GB x 1)
- 8 GB (4 GB x 2)
- 8 GB (8 GB x 1)
- 16 GB (8 GB x 2)
- 16 GB (16 GB x 1)
- 32 GB (16 GB x 2)

System Memory Support

The HP ElitePOS G1 Retail System supports DDR4 protocols with two independent, 64-bit wide channels each accessing one or two SoDIMMs.

- Two channels of non-ECC DDR4 unbuffered small outline dual in-line memory modules (SO-DIMM) with a maximum of one DIMMs per channel
- Single-channel and dual-channel memory organization modes
- Data burst length of eight for all memory organization modes
- Memory data transfer rates of up to 2400 MT/s; actual supported data transfer rate determined by the configured processor.
- 64-bit wide channels
- DDR4 system memory I/O voltage of 1.2V
- Theoretical maximum memory bandwidth of:
- 21.3 GB/s in dual-channel mode assuming 1333 MT/s
- 25.6 GB/s in dual-channel mode assuming 1600 MT/s
- 34.0 GB/s in dual-channel mode assuming 2133 MT/s
- 38.4 GB/s in dual-channel mode assuming 2400 MT/s

Key Benefits of DDR4 Memory:

- Dual channel configuration HP ElitePOS features motherboards designed with two memory channels instead of a single channel.
- Reduce system latencies and significantly improve your system performance with dual channel memory configurations by utilizing the theoretical bandwidth of two memory modules instead of one.
- Expect fast start-up times with reduced delays during routine operations and system maintenance functions.
 Meet everyday workloads head on, and run more programs simultaneously. Easily toggle back and forth between several open applications with noticeable speed.

NOTE: For systems configured with more than 3 GB of memory and a 32-bit operating system, all memory may not be available due to system resource requirements. Addressing memory above 4 GB requires a 64-bit operating system.

Memory modules support data transfer rates up to 2400 MT/s; actual data rate is determined by the system's configured processor. See processor specifications for supported memory data rate.

CAUTION: You must shut down the Retail System and disconnect the power cord before adding or removing memory modules. Regardless of the power-on state, voltage is always supplied to the memory modules as long as the Retail System is plugged in to an active AC outlet. Adding or removing memory modules while voltage is present may cause irreparable damage to the memory modules or system board.



Standard and Configurable Components

HARD DISK AND SOLID STATE STORAGE

Drive Bays

1 (one) M.2 SSD Bays

- SATA
- PCIe (NVME)

M.2 Storage:

M.2 SATA

128GB M2 SATA-3 TLC 256GB M2 SATA-3 TLC SSD 512GB M2 SATA-3 TLC SSD 512GB Turbo Drive G2 MLC SSD

NVMe

128GB TLC 6000p SSD 256GB PCIe NVMe TLC SSD 256GB TLC Pro 6000p SSD 512GB PCIe NVMe TLC SSD 512GB TLC Pro 6000p SSD 1TB PCIe-3x4 NVMe TLC SSD



Standard and Configurable Components

OPERATOR DISPLAY

14" Diagonal Wide-Aspect Operator Value Display (Model 141), Anti-Glare WLED SVA

Touch Technology Projected Capacitive Touchscreen

Resolution 1920 x 1080

Aspect Ratio 16:9 Max Color 262K

Brightness Typical 300 nits (LCM)*

Contrast Ratio Typical 300:1*

Pixel Pitch160.86 um x 160.86 umViewing AngleHorizontal 90°, Vertical 65°Response rate10ms (Typical 0n/0ff)

Backlight LED

Operating Temperature range 0 to 60°C (+ 60°C as panel surface temperature)

14" Diagonal Wide Aspect Projective Capacitive Operator Display (Models 143 & 145), Anti-Glare WLED UWVA

Touch Technology Projected Capacitive Touchscreen

Resolution 1920 x 1080

Aspect Ratio 16:9 Max Color 262K

Brightness Typical 500 nits (LCM)*

Contrast Ratio Typical 800:1

Pixel Pitch 161 um x 161 um

Viewing AngleHorizontal 178°, Vertical 178°Response rate25ms (Typical On / Off)

Backlight LED

Operating Temperature range 0 to 60°C (+ 60°C as panel surface temperature)

*NOTE: Nits is the measure of the typical brightness of the panel as specified, prior to anti-glare coating



Technical Specifications - Audio

High Definition Audio*

ElitePOS System Audio (Realtek ALC3228)

Type Integrated

HD Stereo CodecALC3228 High Definition Audio Codec
Internal Speaker Amplifier
1W amplifier for the internal speaker only.

Sampling All DACs support 44.1k/48k/96k/192kHz sample rate

All ADCs support 44.1k/48k/96k/192kHz sample rate

S/PDIF-OUT support 16/20/24-bit format and 32/44.1/48/88.2/96/192kHz rate

Analog Audio Yes

of Channels on Line-Out Stereo (Left & Right channels)

Internal Speaker Yes

Advanced & Basic I/O Base (Realtek ALC4040)

Type USB

Audio Codec ALC4040 Audio Codec with USB to I2S audio controller and hardware active

noise cancellation

Audio I/O Ports 1 headphone-out/microphone-in combo

Sampling One I2S/PCM/TDM digital interface supports sample rates 8k, 16k, 32k, 44.1k,

48k, 96k, and 192kHz

One stereo DAC supports up to 44.1, 48, and 192KHz Sample Rate, 16/24-bit One stereo ADC Input supports 44.1, 48, and 96KHz Sample Rate, 16/24-bit

Analog Audio Yes
of Channels on Line-Out 2
External Speaker Jack 1

NOTE(Retail Advanced & Basic Hubs Only): Audio input ports are re-taskable as a Line-in or Microphone-in port. External speakers must be powered externally. Multi-streaming can be enabled to allow independent audio streams to be sent to/from the internal speakers and headphone/Line out jack. This allows for different audio applications to use separate audio ports on the system. For example, the Headphone jack could be used with a headphone for a communications application while the internal speakers for a multimedia application.



Technical Specifications – Storage

Introduction:

HP Serial Advanced Technology Attachment (SATA) Hard Drives maximize the performance by providing the technologies to meet your increasing storage demands with high-capacity drives offering superior reliability and performance.

SATA provides faster data transfer speeds, better system cooling airflow, more bandwidth, more headroom for speed increases in future generations and better data integrity. A next-generation technology, the SATA interface connects hard drives to the Platform, enabling easy aggregation of multiple hard drives into a single Retail Point of Sale system. This offers you the additional benefits of dedicated bandwidth, the ability to more easily identify device failures and scalability. The HP ElitePOS Retail System supports the latest SATA 6.0Gb/s specification.

HP Drive Lock

Implementation of the industry standard ATA Security feature set. When enabled, it prevents software access to user data on the drive until one or two user-defined passwords are provided.

SMART IV Technology

Self-Monitoring Analysis and Reporting Technology (SMART) hard drive technology allows hard drives to monitor their own health and to raise flags if imminent failures are predicted. If the drive determines that a failure is imminent, the SMART hard drive technology enables the intelligent manageability or management software to generate a fault alert. While the current versions of SMART hard drives do a good job monitoring the data on the hard drive media, the ever increasing emphasis on reliability and quality has promoted HP to implement SMART IV technology which constantly checks that the data flow from host interface to media and media to host interface is not compromised. This is accomplished by inserting a 2 byte parity code into every 512 byte block in the data path of the hard drive's Cache RAM. This unique parity checking performed by HP's SMART IV technology hard drives, allows for more complete error detection coverage encompassing the entire data path between the host and the hard drive.

Smart IV is also known as IOEDC: I/O Error Detection Code.

Native Command Queuing

NCQ or Native Command Queuing is a SATA protocol extension that allows the hard drive to have several write or read commands outstanding at the same time. In contrast, normal non-queued operation requires each command to be completed before the next command is issued by the host system. Queuing allows the drive to complete the commands in the order that allows for best overall throughput. It also involves an advanced method of transferring data to or from the host, called First Party Direct Memory Access (FPDMA), which allows the hard drive and the host controller to manage the data transfers for multiple outstanding commands, without involving the host processor. NCQ can contribute to better performance but the results are dependent on many factors, including the access patterns of the various applications and operating system functions that are initiating drive accesses. Enabling NCQ features in the hard drive requires AHCI support from the host system BIOS, controller, and driver.

Note: GB = 1 billion bytes. Actual available capacity is less.



Technical Specifications – Storage

Intel 128GB Three Layer Cell 6000p Solid State Drive

Unformatted Capacity 128 GB

3D Tri-Level Cell (TLC) NAND **Architecture**

Interface PCIe NVMe 3.0 x4 **Form Factor** M.2 (80mm) Height Up to 1.5mm Width 22mm Length 80mm Weight Up to 40 a

Bandwidth Performance Sustained Sequential

Read:

Sustained Sequential

Up to 450 MB/s Write: Random Read Up to 40k IOPS **Random Write** Up to 35k IOPS

Useful Drive Life 72TB written, up to 40GB/day for 5 years

Power Power consumption: Active: 200mW Typical Idle: 50mW Typical L1.2 Sleep 5mW Typical

Up to 770 MB/s

Mean Time Between Failure

(MTBF)

1,600,000 Hours

Environmental Operating

Temperature:

(all conditions, non-condensing)

32° to 158° F (0° to 70° C) 2.17 GRMS (5-700Hz) Max

Vibrating - Operating

Vibrating - Non-

Operating

3.13 GRMS (5-800Hz) Max

128GB Solid State M2 SATA-3 Three Layer Cell Drive

0.019 lb (8.5 g)-0.022 lb (10 g) **Drive Weight**

Capacity 128 GB

Height 0.09 in (2.23 mm) - 0.14 in (3.58 mm)

Width 0.87 in (22 mm) Interface **ATA-8, SATA 3.0**

Bandwidth Performance Maximum Sequential

Read:

500 ~ 540 MB/s

Maximum Sequential

Write:

130 ~ 450 MB/s

Logical Blocks 250,069,680

32° to 158°F (0° to 70°C) **Operating Temperature** [ambient temp]

Features DIPM: TRIM: DEVSLP

Security Features ATA Security



Technical Specifications – Storage

256GB M2 SATA-3 Three Layer Cell Solid State Drive

Drive Weight 0.022 lb (10 q)

Capacity 256 GB

Height 0.09 in (2.3 mm) - 0.14 in (3.58 mm)

Width 0.87 in (22 mm) Interface **ATA-8, SATA 3.0**

Bandwidth Performance Maximum Sequential

Read:

515 ~ 540 MB/s

Maximum Sequential

Write:

256 GB

260 ~ 450 MB/s

Logical Blocks 500,118,192

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features DIPM; TRIM; DEVSLP **Security Features ATA Security**

256GB PCIe NVMe Three Layer Cell Solid State Drive

Unformatted Capacity

Architecture

Solid State Drive with TLC NAND Flash and PCIE interface.

Complies with NVMe Standard

Power Saving Modes: L1 substates support

Multi Queue support

Interface PCI-E Gen3 x 4 **Form Factor** M.2 2280 Height 3.73 mm Width 22.00 ± 0.15 mm Length 80.00 ± 0.15 mm

Weight Up to 8 g

Bandwidth Performance Sustained Sequential

Read:

Up to 2600 MB/s

Sustained Sequential

Write:

Up to 1000 MB/s

Power consumption:

Active: Typical 6.1W; Idle: Typical 80mW L1.2: Typical 5mW

Mean Time Between Failure (MTBF)

(all conditions, non-condensing)

Environmental

Power

1,500,000 hours

Operating

Temperature: Relative Humidity: 32° to 158° F (0° to 70° C)

Shock:

1,500 G/0.5 ms

5% to 95%



Technical Specifications – Storage

Intel 256GB Three Layer Cell Pro 6000p Solid State Drive

Unformatted Capacity 256GB*

Architecture 3D Tri-Level Cell (TLC) NAND

InterfacePCIe NVMe 3.0 x4Form FactorM.2 22 x 80mmHeightUp to 1.5mmWidth22mmLength80mm

Weight Up to 40 g

Bandwidth PerformanceSustained Sequential Read:Up to 1570 MB/sSustained Sequential Write:Up to 540 MB/sRandom Read:Up to 80K IOPs

Random Read: Up to 80K IOPs
Random Write: Up to 70K IOPs

Power Total power consumption: 200mW (active); 50mW (idle)

Mean Time Between Failure (MTBF) 1,600,000 Hours

Useful Drive Life 144TB written, up to 80GB/day for 5 years

EnvironmentalOperating Temperature:32° to 158° F (0° to 70° C)(all conditions, non-condensing)Vibrating - Operating:2.17 GRMS (5-700Hz) Max

Vibrating – Non-Operating 3.13 GRMS (5-800Hz) Max

512GB M2 SATA-3 Three Layer Cell Solid State Drive

Drive Weight 0.019 lb (8.5 g)- 0.02 lb (10 g)

Capacity 512 GB

Height 0.09 in (2.3 mm)- 0.14 in (3.58 mm)

 Width
 0.87 in (22 mm)

 Interface
 ATA-8, SATA 3.0

Maximum Sequential 500 ~ 540 MB/s

Bandwidth Performance Read:

Maximum Sequential 440 ~ 515 MB/s

Write:

Logical Blocks 1,000,215,216

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp] **Features** ATA Security, DIPM; TRIM; DEVSLP

512GB PCIe NVMe Three Layer Cell Solid State Drive

Unformatted Capacity 512 GB

Architecture

Solid State Drive with TLC NAND Flash and PCIE interface.

Complies with NVMe Standard

Power Saving Modes: L1 substates support

Multi Queue support



^{*} For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 16 GB (for Windows 7) and 36 GB (for Windows 8.1/10) of system disk is reserved for the system recovery software.

Technical Specifications – Storage

PCI-E Gen3 x 4 Interface **Form Factor** M.2 2280 Height 3.73 mm Width 22.00 ± 0.15 mm

Weight Up to 8 q

Bandwidth Performance Sustained Sequential

Read:

Up to 2600 MB/s

Sustained Sequential

80.00 ± 0.15 mm

Write:

Up to 1200 MB/s

Power consumption:

Active: Typical 6.1W; Idle: Typical 80mW

L1.2: Typical 5mW

Mean Time Between Failure

(MTBF)

Environmental

Power

Length

1,500,000 hours

Operating

(all conditions, non-condensing) **Temperature:**

32° to 158° F (0° to 70° C)

Relative Humidity: Shock:

1,500 G/0.5 ms

5% to 95%

512GB Turbo Drive G2 Multi-Layer Cell Solid State Drive

Drive Weight 0.02 lb (10g) Capacity 512 GB

Height 0.09 in (2.3 mm) ~ 0.14 in (3.65 mm)

Width 0.87 in (22 mm) Interface PCIe NVMe Gen3X4

Maximum Sequential

Read (128KB):

2,260 ~ 3,000 MB/s

Bandwidth Performance

Maximum Sequential

1,500 ~ 1,600 MB/s Write (128KB):

Logical Blocks 1,000,215,216

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features ATA Security (Option); TRIM; L1.2

Intel 512GB Three Layer Cell Pro 6000p Solid State Drive

Unformatted Capacity 512 GB

Architecture 3D Tri-Level Cell (TLC) NAND

Interface PCIe NVMe 3.0 x4

Form Factor M.2 2280 Height Up to 1.5mm Width .22mm Length 80mm Weight (typical) Up to 10 q

Bandwidth Performance Sustained Sequential Read: Up to 1775 MB/s

> **Sustained Sequential Write:** Up to 560 MB/s Random Read: Up to 100k IOPS Random Write: Up to 90k IOPS

Power 200mW (active); 50mW (idle) Total power consumption:

Technical Specifications - Storage

Mean Time Between Failure

(MTBF)

1,600,000 Hours

Useful Drive Life

288 TBW Written, up to 160GB/day for 5 Years

Environmental

Operating Temperature: 32° to 158° F (0° to 70° C) Vibrating - Operating: 2.17 GRMS (5-700Hz) Max

(all conditions, non-condensing)

Vibrating – Non-Operating 3.13 GRMS (5-800Hz) Max

1TB PCIe-3x4 NVMe Three Layer Cell Solid State Drive

 Drive Weight
 0.02 lb (10 g)

 Capacity
 1024 GB

Height 0.09 in (2.3 mm) ~ 0.14 in (3.65 mm)

Width 0.87 in (22 mm)
Interface PCIe NVMe Gen3X4

Bandwidth Performance Maximum Sequential

Read: 2,500 ~ 3,000 MB/s

Maximum Sequential

Write:

1,400~ 1,700 MB/s

Logical Blocks 2,000,409,264

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features ATA Security (Option); TRIM; L1.2



Realtek RTL8153

Power

Connector RJ-45

System Interface PCI Express 1.1 x1 to fully support ASPM LOs/L1 and CLKREQ

NIC Device Driver Name PCIe GBE Ethernet Family Controller

Ethernet Features 10 Mbit/s operation (10BASE-T; IEEE 802.3; IEEE 802.3 clauses 13-14) 100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21-30)

1000 Mbit/s operation (1000BASE-1; IEEE 802.3ab; IEEE 8023 clauses 40)

Auto-Negotiation (Automatic Speed Selection)

Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100 Mbit/s

IEEE 802.1p QoS (Quality of Service) Support

IEEE 802.1q VLAN support

IEEE 802.3x Flow Control (IEEE 802.3 clauses 31-32; configurable)

IEEE 802.3az EEE (Energy Efficient Ethernet)

Jumbo Frame 9K

Auto MDI/MDIX Crossover cable detection ACPI compliant – multiple power modes

Management Situation-sensitive features reduce power consumption

Advanced link down power saving for reducing link down power consumption

Performance TCP/IP/UDP Checksum Offload (configurable)

Features Protocol Offload (ARP & NS)

Large send offload and Giant send offload

Receiving Side Scaling

Manageability Wake-on-LAN from standby and hibernation (Magic Packet and Microsoft Wake-Up Frame); Wake-

on-LAN from off (Magic Packet only)

PXE 2.1 Remote Boot

Statistics Gathering (SNMP MIB II, Ethernet-like MIB, Ethernet MIB (802.3x, clause 30))

Comprehensive diagnostic and configuration software suite

Virtual Cable Doctor for Ethernet cable status

Intel® Dual Band Wireless-AC 8265 802.11a/b/g/n/ac (2x2) WiFi and Bluetooth® 4.2 Combo (non-vPro and vPro)

Wireless LAN Standards IEEE 802.11a

IEEE 802.11b
IEEE 802.11g
IEEE 802.11n
IEEE 802.11ac

Interoperability Wi-Fi certified Frequency Band 802.11b/g/n

• 2.402 - 2.482 GHz

Note:

The FCC has declared as of January 1, 2015 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.

802.11a/n

- 4.9 4.95 GHz (Japan)
- 5.15 5.25 GHz



5.25 – 5.35 GHz
 5.47 – 5.725 GHz
 5.825 – 5.850 GHz

Note: Indonesia no support this band)

Data Rates 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

802.11b: 1, 2, 5.5, 11 Mbps

802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11n: MCS 0 ~ MCS 15 (20MHz and 40MHz)

802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, and 80MHz)

Modulation Direct Sequence Spread Spectrum

CCK, BPSK, QPSK, 16-QAM, 64-QAM, 256-QAM

Security¹

• IEEE and WiFi compliant 64 / 128 bit \

 IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only

AES-CCMP: 128 bit in hardware

802.1x authentication

WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

WPA2 certification

IEEE 802.11i

Cisco Certified Extensions, all versions through CCX4 and CCX Lite

WAPI

Network Architecture

Models

Ad-hoc (Peer to Peer)

Infrastructure (Access Point Required)

Roaming

IEEE 802.11 compliant roaming between band Access Points

Output Power² • 802.11b: +16dBm minimum

802.11g: +14dBm minimum

• 802.11a: +14dBm minimum

802.11n HT20(2.4GHz): +14dBm minimum

802.11n HT40(2.4GHz): +12dBm minimum

802.11n HT20(5GHz): +14dBm minimum

802.11n HT40(5GHz): +12dBm minimum

Power Consumption Transmit: 2.0 W (max) Receive: 1.6 W (max)

Idle mode (PSP): 180 mW (WLAN Associated)
Idle mode: 50 mW (WLAN unassociated)
Connect Standby: 10 mW (WLAN+BT)

Radio disabled: 5 mW

Power Management ACPI and PCI Express compliant power management

802.11 compliant power saving mode

Receiver Sensitivity³ 802.11b, 1Mbps: -94dBm maximum

802.11b, 11Mbps: -86dBm maximum 802.11g, 6Mbps: -88dBm maximum 802.11g, 54Mbps: -74dBm maximum 802.11a, 6Mbps: -88dBm maximum 802.11a, 54Mbps: -74dBm maximum 802.11n, MCS07: -69dBm maximum 802.11n, MCS15: -66dBm maximum 802.11ac, 1SS, MCS-0: -86dBm maximum 802.11ac, 1SS, MCS-9: -61dBm maximum

c05573243 — DA – 16012 Worldwide — Version 4 — September 22, 2017



802.11ac, 2SS, MCS-0 : -83dBm maximum

802.11ac, 2SS, MCS-9: -58dBm maximum

Antenna type High efficiency antenna with spatial diversity, mounted in the display

enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card to

support WLAN MIMO communications and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard

Dimensions Type 2230 : 2.3 x 22.0 x 30.0 mm

0r

Type 1630: 2.3 x 16.0 x 30.0 mm

Weight Type 2230 : 2.8g

0r

Type 1630: 2g

Operating Voltage 3.3v +/- 9%

Temperature Operating 14° to 158° F (-10° to 70° C)

Non-operating —40° to 176° F (–40° to 80° C)

Humidity Operating 10% to 90% (non-condensing)

Non-operating 5% to 95% (non-condensing)

Altitude Operating 0 to 10,000 ft (3,048 m)

Non-operating 0 to 50,000 ft (15,240 m)

LED Activity LED Amber – Radio OFF; LED White – Radio ON

Notes 1. Check latest software/driver release for updates on supported security

features.

 ${\bf 2.\ Maximum\ output\ power\ may\ vary\ by\ country\ according\ to\ local}$

regulations.

3. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and apacket error rate of 10% for 802.11a/q (OFDM

modulation).

* Wireless access point and internet service required. Availability of public wireless access points limited.

HP Integrated Module with Bluetooth 4.0+EDR Wireless Technology (System Bluetooth Specifications)

Bluetooth Specification 4.0+EDR Compliant **Frequency Band** 2402 to 2480 MHz

Number of Available

Channels

79 (1 MHz) available channels

Data Rates and Throughput 3 Mbps data rate; throughput up to 2.17 Mbps

Synchronous Connection Oriented links up to 3, 64 kbps, voice channels Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric

or 1306.9 kbps symmetric

Transmit Power The Bluetooth component shall operate as a Class II Bluetooth device with

a maximum transmit power of +4 dBm for BR and EDR.

Receiver Sensitivity Modulation 0.01% BER 0.001% BER

GFSK -80 dBm -70 dBm $\pi/4\text{-DQPSK}$ -80 dBm -70 dBm

8DPSK -80 dBm -70 dBm

Power Consumption Peak (Tx) 330 mW

Peak (Rx) 230 mW

Selective Suspend 17 mW

Range Up to 33 ft (10 m)

Electrical Interface USB 2.0 compliant

Bluetooth Software Microsoft Windows

Supported

Microsoft Windows Bluetooth Software

Link Topology

Electrical Interface Point to Point, Multipoint Pico Nets up to 7 slaves

Bluetooth Software Supported Security

Full support of Bluetooth Security Provisions

Power Management Power Management

Microsoft Windows ACPI, and USB Bus Support

Power ManagementSelf-configurable to optimize power conservation in all operating modes, including Standby, Hold, Park, and Sniff

Security All necessary regulatory approvals for supported countries, including:

Certifications Bluetooth Profiles FCC (47 CFR) Part 15C, Section 15.247 & 15.249

Supported

Power Management ETS 300 328, ETS 300 826 **Certifications** Low Voltage Directive IEC950

Certifications Bluetooth Profiles Supported UL, CSA, and CE Mark Serial Port Profile (SPP)¹

Service Discovery Application Profile (SDAP)

Dial-Up Networking (DUN)1,2

Generic Object Exchange Profile (GOEP)1,2

Object Push Profile (OPP)^{1,2}
File Transfer Profile (FTP)
Synchronization Profile (SYNC)

Hard Copy Cable Replacement (HCRP)^{1,2} Personal Area Networking Profile (PAN)^{1,2} Human Interface Device Profile (HID)^{1,2}

FAX Profile (FAX)

Basic Imaging Profile (BIP)² Headset Profile (HSP) Hands Free Profile (HFP)

Advanced Audio Distribution Profile (A2DP)

Realtek 802.11b/g/n (1x1) WiFi and Bluetooth® 4.0 Combo

Wireless LAN Standards IEEE 802.11b

IEEE 802.11g IEEE 802.11n

Interoperability Wi-Fi certified



Technical Specifications

Frequency Band

802.11b/g/n

• 2.402 - 2.482 GHz

Note: The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.

802.11b: 1, 2, 5.5, 11 Mbps

• 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

802.11n: MCS 0 ~ MCS 07, (20MHz)

Modulation

Data Rates

Direct Sequence Spread Spectrum BPSK, QPSK, CCK, 16-QAM, 64-QAM,

Security¹

IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only

• AES-CCMP: 128 bit in hardware

802.1x authentication

WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

WPA2 certificationIEEE 802.11i

Cisco Certified Extensions, all versions through CCX4 and CCX Lite

WAPI

Network Architecture

Models Roaming Ad-hoc (Peer to Peer)

Infrastructure (Access Point Required)

Output Power²

IEEE 802.11 compliant roaming between access points 802.11b: +16dBm minimum

802.11n HT20(2.4GHz): +13dBm minimum 802.11n HT40(2.4GHz): +13dBm minimum 802.11n HT20(5GHz): +12dBm minimum 802.11n HT40(5GHz): +12dBm minimum

Power Consumption

Transmit: 2.0 W (max) Receive: 1.6 W (max)

802.11g: +14dBm minimum

Idle mode (PSP): 180 mW (WLAN Associated)
Idle mode: 60 mW (WLAN unassociated)

Radio disabled: 30 mW

Power Management

ACPI and PCI Express compliant power management 802.11 compliant power saving mode

Receiver Sensitivity³

802.11b, 1Mbps: -94dBm maximum 802.11b, 11Mbps: -86dBm maximum 802.11g, 6Mbps: -88dBm maximum 802.11g, 54Mbps: -74dBm maximum 802.11n, MCS07: -69dBm maximum 802.11n, MCS15: -66dBm maximum

Antenna type

High efficiency antenna with spatial diversity, mounted in the display enclosure

Two embedded antennas for 2.4GHz are provided to the card to support WLAN and Bluetooth communications. (Support Dual antenna or Single antenna, depend on platform requirement)

Form Factor PCI-Express M.2 MiniCard

Dimensions Type 2230 : 2.3 x 22.0 x 30.0 mm

0r

Type 1630 : 2.3 x 16.0 x 30.0 mm

Weight Type 2230 : 2.8g

0r

Type 1630: 2g



HP ElitePOS G1 14 inch Touch AiO Retail System

Technical Specifications

Operating Voltage 3.3v +/- 9%

Temperature Operating 14° to 158° F (–10° to 70° C)

Non-operating -40° to 176° F (-40° to 80° C)

Humidity Operating 10% to 90% (non-condensing)

Non-operating 5% to 95% (non-condensing)

Altitude Operating 0 to 10,000 ft (3,048 m)

Non-operating 0 to 50,000 ft (15,240 m)

LED Activity LED Amber – Radio OFF; LED White – Radio ON

1. Check latest software/driver release for updates on supported security features.

2. Maximum output power may vary by country according to local regulations.

3. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).



Technical Specifications

POWER

Power Supply 120W for Basic Retail I/O connectivity Base, 180W for Advanced Retail I/O connectivity Base, 65W for

Display Head Unit Only

120W, 88% efficient, active PFC (external), 180W, 89% efficient, active PFC (external), 65W, 89%

efficient at 20V, active PFC (external)

Operating Voltage Range 90V~264VAC Rated Voltage Range 100V~240AC Rated Line Frequency 50~60HZ Operating Line Frequency 47~63HZ

Range

Rated Input Current <2.2A/120W, <2.52A/180W, 1.7A/65W

Power Supply Fan N/A

ENERGY STAR® Compliant ENERGY STAR® certified and EPEAT® registered configurations available

Power Cord Length 2 I/O Base Cable Options:

(1) 45cm - when I/O Base is attached to Stand

(2) 1.8m – when I/O Base is detached or display head only

Current Leakage (NFPA99) Less than 300 microamps of leakage current at 120 Vac with the ground wire disconnected, as

required for Non-patient Electrical Appliances and Equipment used in a patient care facility or that contact patients in normal use. Per section 10.3.5.1 of "National Fire Protection Association

standard" NFPA99 2012 edition.

Less than 100 microamps of leakage current at 120 Vac with the ground wire intact with normal polarity, as required for Non-patient Electrical Appliances and Equipment used in a patient care facility or that contact patients in normal use. Per section 10.3.5.1 of "National Fire Protection"

Association standard" NFPA99 2012 edition.

NOTE: This power supply meets ENERGY STAR® compliance in conjunction with a select range of

processors and modules.

WEIGHTS & DIMENSIONS

NOTE: Weight and dimensions below do not include MSR, Biometric Reader, Webcam, or CFD.

Head unit (no MSR)	
Product Dimensions	336.2mm (L) X 216.4mm (D) X 17.6mm (H) , 13.2in x 8.5in x .7in
Dimension Note	Without stand

Rotate / tilt stand & fixed position	
stand/Column Printer	
Product Dimensions	96(L) x 96(D) x 220(H) mm / 260 (H) mm, 3.8in (L) x 3.8in (D) x 8.7in (H) /
	10.2in (H)
Dimension Note	Fixed Position Stand & Rotate Tilt Stand w/ Integrated Column Printer

Retail I/O connectivity Base	
Product Dimensions	284 (L) x 162(D) x 29.2(H) mm, 11.2in (L) x 6.4in (D) x 1.1in (H)
Dimension Note	Connectivity Base Only



Technical Specifications

Display Head Unit with collar	
Weight	1.4 kg / 3.1 lbs
Weight Note	Starting weight without stand. Exact weight depends on configuration.

Rotate / Tilt Stand	
Weight	1.3 kg / 3.0 lbs
Weight Note	Weight of Rotate/Tilt Stand only

Fixed Position Stand	
Weight	1.1 kg / 2.4 lbs
Weight Note	Weight of Fixed Position Stand only

Retail I/O Connectivity Base	
Weight	.6 kg / 1.3 lbs
Weight Note	Weight of Connectivity Base only

Packaging Carton (Display Head & Hub Only)	
Packaging Dimensions	552mm (L) X 165mm (D) X 318mm (H) , 21.7in x 6.5in x 12.5in

Packaging Carton (Display Head, Stand & Hub)	
Packaging Dimensions	495mm (L) X 295mm (D) X 453mm (H) , 19.5in x 11.6in x 17.8in

Bundled Packaging	
Weight	11.8 kg / 26 lbs
Weight Note	Weight of Bundled Packaging only

Display Head Only Packaging	
Weight	4.3 kg / 9.3 lbs
Weight Note	Weight of Display Head Packaging only

Standard Packaging	
Weight	7.2 kg / 15.9 lbs
Weight Note	Weight of Standard Packaging only



Technical Specifications

MISCELLANEOUS FEATURES

Management Features

- Advanced Configuration and Power Management Interface (ACPI). Allows the system to wake from a low power mode.
- Controls system power consumption, making it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system.
- Intel® Wired for Management support; industry wide initiative to make Intel® architecture based PCs, servers and mobile computers more inherently manageable out-of-the-box and over the network
- Dual State Power Button; acts as both an on/off button and a suspend-to-sleep button

HP Point of Sale Diagnostics UEFI:

This utility enables hardware level testing outside the operating system on many components. The diagnostics can be invoked by pressing F2 at POST, and is available as a download from HP Support

Serviceability Features:

- System/Emergency ROM
- Flash ROM
- Flash Recovery with Video Configuration Record Software
- Over-Temp Warning on Screen (Requires IM Agents)
- Clear Password Jumper
- Clear CMOS Button
- Color coordinated cables and connectors
- Front power switch
- System memory can be upgraded without removing the system board or any internal components

Interpreting System Validation Diagnostic Front Panel LEDs and Audible Codes

During the system validation phase that occurs at system startup, the BIOS validates the functionality of the following subsystems and conditions:

- AC adapter
- System board power
- Processor failure
- **BIOS** corruption
- Memory failure
- **Graphics failure**
- System board failure
- **BIOS** authentication failure

If an error is detected, specific patterns of long and short blinks, accompanied by long and short beeps (where applicable) are used to identify the error. These patterns will make up a two part code:

- Major the category of the error
- Minor the specific error within the category



NOTE: Single beep/blink codes are not used.

Number of long beeps/blinks	Error category
1	Not used
2	BIOS



Technical Specifications

3	Hardware
4	Thermal
5	System board

Patterns of blink/beep codes are determined by using the following parameters:

- 1 second pause occurs after the last major blink.
- 2 second pause occurs after the last minor blink.
- Beep error code sequences occur for the first 5 iterations of the pattern and then stop.
- Blink error code sequences continue until the computer is unplugged or the power button is pressed.



NOTE: Not all diagnostic lights and audible codes are available on all models.

The red LED blinks to represent the major error category (long blinks). The white LED blinks to represent the minor error category (short blinks). For example, '3.5' indicates 3 long red blinks and 5 short white blinks to communicate the processor is not detected.

Category	Major/minor code	Description
BIOS	2.2	The main area (DXE) of BIOS has become corrupted and there is no recovery binary image available.
	2.3	The embedded controller policy requires the user to enter a key sequence.
	2.4	The embedded controller is checking or recovering the boot block.
Hardware	3.2	The embedded controller has timed out waiting for BIOS to return from memory initialization.
	3.3	The embedded controller has timed out waiting for BIOS to return from graphics initialization.
	3.4	The system board displays a power failure (crowbar).*
	3.5	The processor is not detected.*
	3.6	The processor does not support an enabled feature.
Thermal	4.2	A processor over temperature condition has been detected.*
	4.3	An ambient temperature over temperature condition has been detected.
	4.4	An MXM over temperature condition has been detected.
System board	5.2	The embedded controller cannot find valid firmware.
	5.3	The embedded controller has timed out waiting for the BIOS.
	5.4	The embedded controller has timed out waiting for BIOS to return from system board initialization.
	5.5	The embedded controller rebooted the system after a possible lockup condition had been detected through the use of a System Health Timer, Automated System Recovery Timer, or other mechanism.

Indicates hardware triggered event; all other events are controlled by the BIOS.

Additional Features

Description



Technical Specifications

Drive Lock Implementation of the industry standard ATA Security feature set. When enabled, it prevents software

access to user data on the drive until one or two user-defined passwords are provided.

DPS Access through F10 Setup during Boot

A diagnostic hard drive self-test. It scans critical physical components and every sector of the hard drive for physical faults and then reports any faults to the user

Drive Protection System Running independently of the operating system, it can be accessed through a

Windows-based diagnostics utility or through the computer's setup procedure. It produces an evaluation on whether the hard drive is the source of the problem and

needs to be replaced

The system expands on the Self-Monitoring, Analysis, and Reporting Technology (SMART), a continuously running systems diagnostic that alerts the user to certain

types of failures

SMART Technology (Self-Monitoring, Analysis and Reporting Technology)

SMART Technology (Self- Allows hard drives to monitor their own health and to raise flags if imminent failures

were predicted

SMART I - Drive Failure

Prediction

Predicts failures before they occur. Tracks fault prediction and failure indication parameters such as re-allocated sector count, spin retry count, calibration retry count

SMART II - Off-Line Data

Collection

By avoiding actual hard drive failures, SMART hard drives act as "insurance" against

unplanned user downtime and potential data loss from hard drive failure

SMART III - Off-Line Read

Scanning

IOEDC: I/O Error Detection Circuitry

Defect Reallocation

SMART IV - End-to-End CRC for hard drives Detects errors in Read/Write buffers on HDD cache RAM

Interface in F10 setup provides confirmation of SMART IV support.

TEMPERATURE, HUMIDITY, ALTITUDE

Temperature Operating 50° to 104° F (10 to 40° C)

Non-operating -22° to 149° F (-30° to 65° C)

Relative humidity Operating 20 to 85%

 Altitude
 Operating
 0 to 10,000 ft (3,048 m)

 (unpressurized)
 Non-operating
 0 to 30,000 ft (9,144 m)



100VAC 60Hz

Sound Pressure

(L_{DAm}, decibels)

17

QuickSpecs

Technical Specifications

ENVIRONMENTAL & INDUSTRY

Environmental Data

Eco-Label Certifications & declarations

This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:

- IT ECO declaration
- US ENERGY STAR®

115VAC 60Hz

EPEAT® Gold registered in the United States. See http://www.epeat.net for registration status in your country.

System Configuration

The configuration used for the Energy Consumption and Declared Noise Emissions data for the ElitePOS model is based on a typically configured system featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.

230VAC 50H2

HP ElitePOS G1 Model 141

Energy Consumption
(in accordance with US ENERGY
STAR® test method)

STAR" (est illetilou)	I I SVAC, OUNZ	ZSUVAC, SUNZ	IUUVAC, OUNZ
Normal Operation (Short idle)	12.58W	13.07W	12.65 W
Normal Operation (Long idle)	10.71 W	10.96W	10.79 W
Sleep	3.28 W	3.31W	3.26W
Off	1.15W	1.18 W	1.15 W
Heat Dissipation*	115VAC, 60Hz	230VAC, 50Hz	100VAC, 60Hz
Normal Operation (Short idle)	42.89 BTU/hr	44.59 BTU/hr	43.02 BTU/hr
Normal Operation (Long idle)	36.54 BTU/hr	37.39 BTU/hr	36.74 BTU/hr
Sleep	11.15 BTU/hr	11.29 BTU/hr	11.12 BTU/hr
Off	3.92 BTU/hr	3.99 BTU/hr	3.92 BTU/hr

Sound Power

(L_{WAd}, bels)

^{*} Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour

Declared Noise Emissions
(in accordance with
ISO 7779 and ISO 9296)
Tupically Configured Idla

Typically Configured – Idle 2.7
Fixed Disk – Random writes 2.7

2.7	17
NOTE: Energy efficiency data listed is for an ENERG	GY STAR® compliant product if offered within
the model family . HP computers marked with the	ENERGY STAR® Logo are compliant with the
applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR® specifications for
computers. If a model family does not offer ENERG	GY STAR® compliant configurations, then
energy efficiency data listed is for a typically confi	gured PC featuring a hard disk drive, a high

HP ElitePOS G1 Model 143/145

Energy Consumption
(in accordance with US ENERGY
STAR® test method)

STAR® test method)	115VAC, 60Hz	230VAC, 50Hz	100VAC, 60Hz
Normal Operation (Short idle)	12.58W	13.07W	12.65 W
Normal Operation (Long idle)	10.71 W	10.96W	10.79 W
Sleep	3.28 W	3.31W	3.26W
Off	1.15W	1.18 W	1.15 W



efficiency power supply, and a Microsoft Windows® operating system.

Heat Dissipation*	115VAC, 60Hz	230VAC, 50Hz	100VAC, 60Hz
Normal Operation (Short idle)	42.89 BTU/hr	44.59 BTU/hr	43.02 BTU/hr
Normal Operation (Long idle)	36.54 BTU/hr	37.39 BTU/hr	36.74 BTU/hr
Sleep	11.15 BTU/hr	11.29 BTU/hr	11.12 BTU/hr
Off	3.92 BTU/hr	3.99 BTU/hr	3.92 BTU/hr

^{*} Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour

Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)	Sound Power (L _{WAd} , bels)	Sound Pressure (L _{pAm} , decibels)
Typically Configured – Idle	2.7	17
Fixed Disk – Random writes	2.7	17



Longevity and Upgrading

This product can be upgraded, possibly extending its useful life by several years. Upgradeable features and/or components contained in the product may include:

- 2 memory slots
- M.2 2230 slot for WLAN
- (1) M.2 2280 slot for SSD
- (4) USB Ports (2 USB 2.0; 2 USB 3.0) Plug in ports for 2 bases
- (3) USB Ports for Peripheral Integration around display head (Top, Left, Right)

Spare parts are available throughout the warranty period and or for up to "5" years after the end of production.

Batteries

This battery(s) in this product comply with EU Directive 2006/66/EC

Batteries used in the product do not contain: Mercury greater the1ppm by weight Cadmium greater than 20ppm by weight

Battery size: CR2032 (coin cell)

Battery type: Lithium

Additional Information

- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive 2011/65/EC.
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive – 2002/96/EC.
- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- This product is in compliance with the IEEE 1680 (EPEAT) standard at the <gold> level, see www.epeat.net
- Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043.
- This product contains 25.4% post-consumer recycled plastic (by wt.)
- This product is 96% recycle-able when properly disposed of at end of life.

Packaging Materials

Material Usage

External: PAPER/Corrugated

1350 g

Internal:

PLASTIC/EPE (Expanded Polyethylene)

575 g

The EPE foam packaging material is made from 0% recycled content.

The corrugated paper packaging materials contains at least 25% recycled content.

This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at

http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf):

- Asbestos
- Certain Azo Colorants
- Certain Brominated Flame Retardants may not be used as flame retardants in plastics
- Cadmium
- Chlorinated Hydrocarbons
- Chlorinated Paraffins
- Formaldehyde
- Halogenated Diphenyl Methanes
- Lead carbonates and sulfates
- Lead and Lead compounds
- Mercuric Oxide Batteries



- Nickel finishes must not be used on the external surface designed to be frequently handled or carried by the user.
- Ozone Depleting Substances
- Polybrominated Biphenyls (PBBs)
- Polybrominated Biphenyl Ethers (PBBEs)
- Polybrominated Biphenyl Oxides (PBBOs)
- Polychlorinated Biphenyl (PCB)
- Polychlorinated Terphenyls (PCT)
- Polyvinyl Chloride (PVC) except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.
- Radioactive Substances
- Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)

Packaging Usage

HP follows these guidelines to decrease the environmental impact of product packaging:

- Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.
- Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
- Design packaging materials for ease of disassembly.
- Maximize the use of post-consumer recycled content materials in packaging materials.
- Use readily recyclable packaging materials such as paper and corrugated materials.
- Reduce size and weight of packages to improve transportation fuel efficiency.
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.

End-of-life Management and Recycling

HP Inc. offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.

The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the HP Inc. web site at: http://www.hp.com/go/recyclers. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.

HP Inc. Corporate Environmental Information

For more information about HP's commitment to the environment

Global Citizenship Report

http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html

Eco-label certifications

http://www8.hp.com/us/en/hp-information/environment/ecolabels.html

ISO 14001 certificates:

PC Product Design ISO 14001 certificate

and

HP Operations ISO 14001 certificate

SERVICE AND SUPPORT



Ninety-day (90-90-90), one-year (1-1-1), and three-year (3-3-3) limited warranty delivers (ninety days/one year/three years) of on-site, next business day² service for parts and labor and complimentary limited technical support.³ Three-year onsite and labor are not available in all countries. Service offers terms up to 5 years by choosing an optional HP Care Pack.¹ To choose the right level of service for your HP product, visit HP Care Pack Central: http://www.hp.com/go/cpc

NOTES:

- 1. Terms and conditions may vary by country. Certain restrictions and exclusions apply. Other warranty variations may be offered in your region.
- 2. On-site service may be provided pursuant to a service contract between HP and an authorized HP third-party provider, and is not available in certain countries. Global service response times are based on commercially reasonable best effort and may vary by country.
- 3. Technical support applies only to HP-configured Compaq and third-party HP-qualified hardware and software. 24 x 7 support may not be available in some countries.



HP ElitePOS Peripherals

HP ElitePOS Serial USB Thermal Printer



Models

HP ElitePOS Serial USB Thermal Printer

1RL96AA

HP ElitePOS Peripherals

General

Supported Character Sets Resident Code Pages:

437 (US) 720(Arabic) 737 (Greek) 775 (Lithuanian) 850 (Multilingual) 852 (Slavic) 857 (Turkish)

858 (with Eurosymbol) 860(Portuguese) 862(Hebrew)

863 (French Canadian)

864 (Arabic) 865 (Nordic) 866 (Cyrillic) 874 (Thai) 932 (Kanji)

936 (Simplified Chinese) 949 (Korean - Hangul) 950 (Traditional Chinese) KZ_1048 (Kazakh) 1250 (Latin) 1251 (Cyrillic)

1252 (Windows Latin I)

1254 (Turkish) 1255 (Hebrew) 1256(Arabic) 1257(Baltic) Katakana

28591 (ISO8859-1, Latin 1) 28592 (ISO8859-2, Latin 2) 28594 (ISO8859-4, Latin 4) 28596 (ISO8859-6, Latin/Arabic) 28599 (ISO8859-5, Latin 5/Turkish)

28605 (ISO8859-15, Latin 9)

Unicode UTF-8 encoding for listed code pages

Bar Codes 1D: UPC-A, UPC-E, EAN8, EAN13, Code 39, Code 93, Interleaved 2 of

5

Codabar, Code 128, Code 128, EAN 128, GS1 Databar

2D: Datamatrix, QR code, PDF 417

Print Method Direct Thermal

Printing Speed 114 mm/sec (33.75 LPS)

Resolution203 DPIFlash Memory8 MBRAM8 MB

Knife Full and Partial cuts supported

Receipt-Columns 44/56



Paper Type Direct Thermal Monochrome POS Grade(s)

Paper Roll Size (W x D) 3.1 in. X 3.26 in. (80 mm X 83 mm)

Paper Thickness Range 2.3 – 3.2 mil

Cash Drawers 1 connector can drive 2 cash drawers with separately purchased splitter

cable (default configuration is connection to 1 cash drawer)

Mechanical Dimensions (WxDxH) 4.4 in. X 5.2 in. X 4.06 in. (111.8 mm X 131.6 mm X 103 mm)

Weight 1.75lbs. (.793 kg) (printer only)

Color Ebony black

Interface/Connection Interface RS232 (9-Pin Female to 9-Pin Female NULL modem cable) or standard

USB 2.0 cable.

24V Cash Drawers support with RJ 12 interface

Power External Power Supply 48 w

Operating Voltage 24 V

Full Load Current 2 A w/active power management system

Idle Current25mAIdle Power0.6 W

Temperature Range Operating 41°F to 95°F (5°C to 35°C) at 5% to 90% humidity

95°F to 122°F (35°C to 50°C) at 5% to 40% humidity

Non-operating Transit range: -40°F to 140°F (-40°C to 60°C) 5% to 95% humidity

Storage range: 14°F to 122°F (35°C to 50°C) at 5% to 90% humidity

Drivers Windows, OPOS, JPOS

OperatingSystems Windows

Windows 10 IoT Enterprise for Retail (64-bit)

Windows 10 Pro (64-bit)

Linux

Red Hat/CentOS 6 and 7 (32-bit and 64 bit)

Suse Linux® Enterprise POS 11 and 12 (32-bit and 64-bit)

Ubuntu 14.04 LTS (32-bit and 64-bit)

Reliability MCBF Print Mechanism: 29-million lines

MCBF Knife Cuts: 1-million Print Head Life: 100 km

Agency Certifications Flammability: UL 94V-0

Safety: UL 60950-1 2nd edition 2014-10-14; UL 62382-1 CAN/CSA C22.2 No. 60950-1-07, 2nd Edition, 2014-10

EN 60950-1:2006 + A1:2010+ A2:2013

IEC/EN 62382-1 2ND Edition

CB Report: IEC 60950-1:2005 + A1:2009 +A2:2013

GB4943.1-2011-China

IS 13252-1 (2010)/A1:2013/A2:2015

Radiated Emissions: FCC 47CFR, Part 15, Class B

ICES-003: 2012, Issue 6, Class B



HP ElitePOS Peripherals

EN 55032:2015 Class B CISPR22 Class B VCCI: V-3/2015.04 Class B AS/NZS 3548

Immunity: EN55024: 2010

EN61000-4-2 Level 4 (8kV direct, 15kV air discharge)

EN61000-4-3: Level 3 (10V/m) EN61000-4-6 Level 3 (10V rms)

EN61000-4-4: Level 3 (2kV mains, 1kV data lines)

RoHS, WEEE

Option kit contents

HP ElitePOS Serial USB Thermal Printer, Starter paper roll

NOTE: This printer does not comply with fiscalization requirements that may be required in certain countries.

Cable kits sold separately:

1RM02AA – HP ElitePOS USB + Pwr Adapter 1RM03AA – HP ElitePOS Serial + Pwr Adapter BM477AA– HP ElitePOS PUSB Y Cable 1RM05AA – HP ElitePOS PUSB Pw only

HP ElitePOS 2D Barcode Scanner



Model

HP ElitePOS 2D Barcode Scanner 1RL97AA

General

Scanner Type 2D Imager Light source White LED

Read Rate 30 frames/seconds
Nominal working Depth of Field
distance Minimum distance of

Minimum distance determined by symbol length and scan angle. Printing resolution, contrast, and ambient light dependent.

Typical Performance *

Narrow Width	Depth of Field
10 mil Code 39	27.94-330.2 mm (1.1-13.0")
10 mil Code 128	27.94-330.2 mm (1.1-13.0")
100% UPC-A	45.72-419.1 mm (1.8-16.5")
10 mil Aztec	53.34-203.2 mm (2.1-8.0")
6.7 mil PDF 417	45.72-182.88 mm (1.8 - 7.2")
10 mil DM**	53.34-203.2 mm (2.1 – 8.0")



* Performance may be impacted by bar code quality and environmental conditions

** Data Matrix (DM)

Symbol Contrast 35% minimum reflectance difference

Roll (tilt) $\pm 360^{\circ}$ Pitch $\pm 60^{\circ}$ Skew $\pm 70^{\circ}$

1D decode symbologies UPC/EAN (A)

UPC/EAN (E) UPC/EAN/ (13) UPC/EAN (8) Code 39 (Regular)

Code 128 EAN 128 Code 93

GS1 Databar Omnidirectional

GS1 DataBar Stacked GS1 DataBar Truncated GS1 Databar Expanded UPC/EAN/JAN (ISBN) UPC/EAN/JAN (Bookland) UPC/EAN/JAN (ISSN)

ISSN - 2

EAN 13/P2 (with 2 digits Add-On) EAN 13/P5 (with 5 digits Add-On) Code 39 (including full ASCII) Code39 CIP (French Pharmaceutical)

Code 39 (trioptic)

LOGMARS (Code 39 w/ standard check digit enabled)

Code 32 (Italian Pharmacode 39)

Interleaved 2 of 5 Standard 2of 5 Industrial 2 of 5

Code 11 (with two check digits) Code 11 (with one check digit)

Codabar MSI

PZN - code 39 GS1 DataBar Limited

Codablock F

2D decode symbologies Datamatrix

QR Codes (QR, Micro QR and Multiple QR Codes)

PDF-417 Aztec Maxicode Micro PDF417

Datamatrix (2D inversed) Chinese Sensible Code

GS1 DataBar Stacked Omni-directional GS1 DataBar Expanded Stacked

Postal Codes

Australian



Japanese Planet Postnet Royal Mail

Mechanical

Dimensions (L x W x H) 125 x 44 x 76.8 mm (4.92 x 1.73 x 3.02 in)

Weight 130 g (4.59 oz)

Cable length 2m

Color Ebony Black

Interface/Connection

Cable USB

Temperature

 Operating
 32°F to 122°F (0°C to 50°C)

 While Charging
 32°F to 104°F (0°C to 40°C)

 Storage/transport
 -40 to 158 °F (-40 to 70 °C)

 Humidity (non 0 to 95% relative humidity

condensing)

Power

Idle Current Standby/Idle (Typical):< 70mA

Input Voltage 5V, 500mA

Drivers

Windows USB COM, OPOS, and JPOS

Operating System

Compatible with: Windows

Windows 10 IoT Enterprise for Retail (64-bit)

Windows 10 Pro (64-bit)

Linux

Red Hat/Cento 6 and 7 (32-bit and 64-bit)

Suse Linux® Enterprise POS 11 SP3 (32-bit and 64-bit)

Ubuntu 14.04 LTS (32-bit and 64-bit)

Agency Certifications

C-Tick, KCC, BSMI, VCCI, CSA, CE, FCC

Option Kit Contents

HP ElitePOS 2D Barcode Scanner with attached 6.5 ft (2M) USB cable, Scanner Stand.



HP ElitePOS Fingerprint Reader



Models

HP ElitePOS Fingerprint Reader 1RL98AA

Model **HP ElitePOS Fingerprint Reader** 1RL98AA

General **Scan Data** 8-bit grayscale (256 levels of gray)

> **Pixel resolution** 508 DPI

Scan capture area 18mm x 1280mm

Mechanical Standalone Dimensions(LxWxH) 162 x 30 x 20.7 (mm) (6.38 x 1.18 x .81 in)

> Attached Dimensions (LxWxH) 162x30 x29.2 (mm) (6.38 x 1.18 x 1.15 in)

Standalone Weight 79g (2.79 oz) **Attached Weight** 116g (4.09 oz)

Color **Ebony Black** Interface **USB 2.0**

Power

Supply Voltage 5.0V ±5% supplied by USB



Interface/Connection

Drivers

Supply Current Imaging Mode 80 mA @ 3.3V **Supply Current Sleep Mode** 1350 uA @ 3.3

Supply Current Sleep Mode 1350 uA @ 3.3 V**Environmental Temperature** -20 C to + 70 C

Humidity 5% to 93% RH w/o condensation

Windows

Operating Systems Compatibility Windows

Windows 10 IoT Enterprise for Retail 64-bit*,***

Windows 10 Professional 64-bit*,***
Windows 8.1 Professional 64-bit**

Windows Industry 8.1 Pro Retail 64-bit**

Windows 7 Professional 64-bit**
Windows 7 Professional 32-bit**

Windows Embedded POSReady 7 64-bit**
Windows Embedded POSReady 7 32-bit**

Linux

Ubuntu 12.04 Ubuntu 13.04 Ubuntu 14.04

Reliability Surface Coating Scratch Resistant

Withstands more than 4 million rubs

Readability More than 100,000 read/write cycle

More than 20 yrs data retention

Works well with dry, moist, or rough fingerprints

Security Counterfeit Finger Rejection

Latent Print Rejection
Encryption Fingerprint Data

^{**} Not all features are available in all editions of Windows. This system may require upgraded and/or separately purchased hardware to take full advantage of Windows functionality. See http://www.microsoft.com.



^{*} Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See http://www.microsoft.com

*** Full support on all x86-based Windows, NO current support drivers for ARM processor platforms.

HP ElitePOS Top Mount 2x20 CFD



Models

HP ElitePOS Top Mount 2x20 CFD 1RL95AA

General Display Type TFT LCD

Resolution 480(W) x 3(RGB) x 64(H) Pixel Dots

Average Brightness 600 cd/m²

Display Mode Alphanumeric: 20 digits x 2 lines

 Character Dot Matrix
 24x32 dots for 20 x 2

 Dot Size (X *Y)
 0.279 (W) x 0.281 (H) mm

Character Type Alphanumeric and Compound (2-Bytes) Words

Character Size 9.0 (H) mm x 6.7 (W) mm

User Define Character 96 characters



HP ElitePOS Peripherals

Language Compound (2-Bytes Words):

Arabic Japanese Korean Persian

Simplified Chinese Traditional Chinese **Alphanumeric:** Bosnian

Croatian
Czech
Danish
Dutch
English (US)
Estonian
Faroese
Finnish
Flemish
French

French Canadian

German Greek Hebrew Hungarian Icelandic Indonesian

International English

Irish
Italian
Katakana
Latvian
Lithuanian
Norwegian
Polish
Portuguese
Romanian
Russian
Slovak
Slovene
Spanish
Swedish

Turkish

Viewing Direction 12 O'clock : Customer application

6 O'clock: Gray scale inversion

Viewing Area 135.28 (W) * 19.0 (L)

Viewing Angle $\theta_L \Phi = 180^{\circ} (9 \text{ o'clock}) 70 \text{ degree}$

 $\Theta_R \Phi = 0^\circ$ (3 o'clock) 70 degree $\Theta_T \Phi = 90^\circ$ (12 o'clock) 50 degree $\Theta_B \Phi = 270^\circ$ (6 o'clock) 70 degree

Command Modes ADM788, AEDEX, CD5520, DSP880, EMAX, Epson, LD540, Logic Control,

UTC/P / UTC/S

Mechanical Product Dimensions 157.47 (W) x 34.47 (H) x 12.9 (D) mm (6.2 x 1.36 x .51 in) (metal bracket for

inserting to platform excluded)

Panel Dimensions 148.9 (W) x 29.1 (L) x 3.35 (H) (5.86 x 1.15 x .132 in)

Net Weight Approx. 110 grams (3.88 oz)

Color Ebony Black

Interface/Connection Interface USB

Baud Rate Direct connection 9600

Power Voltage (typical) 5VDC +/-10%

Current consumption

(typical)

400mA

Reliability MTBF 30,000 hours

Operating Systems Windows

(Compatible with) Windows 10 IoT Enterprise for Retail (64-bit)*

Windows 10 Pro (64-bit)*

Linux

Red Hat/Cento 6 and 7 (32-bit and 64-bit)

Suse Linux® Enterprise POS 11 SP3 (32-bit and 64-bit)

Ubuntu 14.04 LTS (32-bit and 64-bit)

DriversWindows USB COM, OPOS, JPOSCertificationsFCC, CE, VCCI, RCM, KCC, ICE, CSA, EACKit ContentsHP ElitePOS Top Mount 2x20 CFD, 2 screws



^{*} Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See http://www.microsoft.com.

^{**}Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. See http://www.microsoft.com.

HP ElitePOS Peripherals

HP ElitePOS Column Printer



Models

HP ElitePOS Column Printer

Configurable option only. Not available as after-market option.

General

Supported Character Sets Resident Code Pages:

437 (US) 720 (Arabic) 737 (Greek) 775 (Lithuanian) 850 (Multilingual) 852 (Slavic) 857 (Turkish)

858 (with Eurosymbol) 860 (Portuguese) 862 (Hebrew)

863 (French Canadian)

864 (Arabic) 865 (Nordic) 866 (Cyrillic) 874 (Thai) 932 (Kanji)

936 (Simplified Chinese) 949 (Korean - Hangul) 950 (Traditional Chinese) KZ_1048 (Kazakh) 1250 (Latin) 1251 (Cyrillic) 1252 (Windows Latin

1) 1254 (Turkish) 1255 (Hebrew) 1256 (Arabic) 1257 (Baltic) Katakana

28591 (ISO8859-1, Latin 1) 28592 (ISO8859-2, Latin 2) 28594 (ISO8859-4, Latin 4) 28596 (ISO8859-6, Latin/Arabic) 28599 (ISO8859-5, Latin 5/Turkish) 28605 (ISO8859-15, Latin 9)

Unicode UTF-8 encoding for listed code pages

Bar Codes 1D: UPC-A, UPC-E, EAN8, EAN13, Code 39, Code 93, Interleaved 2 of 5

Codabar, Code 128, Code 128, EAN 128, GS1 Databar

2D: Datamatrix, QR code, PDF 417

Print Method Direct Thermal

Printing Speed 114 mm/sec (33.75 LPS)

Resolution 203 DPI Flash Memory 8 MB RAM 8 MB

Knife Full and Partial cuts supported



Receipt-Columns 44/56

Paper Type Direct Thermal Monochrome POS Grade(s)

Paper Roll Size (W x D) 3.1 in. X 2 in. (80 mm X 51 mm)

Paper Thickness Range 2.3 – 3.2 mil

Cash Drawers 1 connector can drive 2 cash drawers with separately purchased splitter

cable (default configuration is connection to 1 cash drawer)

Mechanical Dimensions (DxH) 3.78 in. (D) x 5.5 in. (H) (96 mm x 140 mm)

Color Ebony black

Interface/Connection Interface Standard USB 2.0 cable Type A to Type B mini

24V Cash Drawers support with RJ 12 interface

Power External Power Supply 48 w

Operating Voltage 24 V

Full Load Current 2 A w/ active power management system

Idle Current25mAIdle Power0.6 W

Temperature Range Operating 41°F to 95°F (5°C to 35°C) at 5% to 90% humidity

95°F to 122°F (35°C to 50°C) at 5% to 40% humidity

Non-operating Transit range: -40°F to 140°F (-40°C to 60°C) 5% to 95% humidity

Storage range: 14°F to 122°F (35°C to 50°C) at 5% to 90% humidity

Drivers Windows, OPOS, JPOS

Operating Systems Windows

Windows 10 IoT Enterprise for Retail (64-bit)

Windows 10 Pro (64-bit)

Linux

Red Hat/CentOS 6 and 7 (32-bit and 64 bit)

Suse Linux® Enterprise POS 11 and 12 (32-bit and 64-bit)

Ubuntu 14.04 LTS (32-bit and 64-bit)

Reliability MCBF Print Mechanism: 29-million lines

MCBF Knife Cuts: 1-million Print Head Life: 100 km

Agency Certifications Flammability: UL 94V-0

Safety: UL 60950-1 2nd edition 2014-10-14; UL 62382-1 CAN/CSA C22.2 No. 60950-1-07, 2nd Edition, 2014-10

EN 60950-1:2006 + A1:2010+ A2:2013

CB Report: IEC 60950-1:2005 + A1:2009 +A2:2013

IEC/EN 62382-1 2ND Edition

HP ElitePOS Peripherals

GB4943.1-2011-China IS 13252-1 (2010)/A1:2013/A2:2015

Radiated Emissions: FCC 47CFR, Part 15, Class B

ICES-003: 2012, Issue 6, Class B EN 55032:2015 Class B CISPR32 VCCI: V-3 Class B ITE VCCI-CISPR32 AS/NZS 3548

Immunity: EN55024: 2010

EN61000-4-2 Level 4 (8kV direct, 15kV air discharge)

EN61000-4-3: Level 3 (10V/m) EN61000-4-6 Level 3 (10V rms)

EN61000-4-4: Level 3 (2kV mains, 1kV data lines)

RoHS, WEEE

Option kit contents Starter paper roll

NOTE: This printer does not comply with fiscalization requirements that may be required in certain countries.



HP ElitePOS MSR



Models

HP ElitePOS MSR

Configurable option only. Not available as after-market option.

General Magnetic stripe formats ISO 7811, AAMVA

Type Singe-head, bi-directional, 3-Track, encryption capable

Card thickness 0.015 to 0.045 in (0.38 to 1.14 mm)

Indicators Bi-colored LED, beeper (requires system audio driver)

Mechanical

Slot width 0.045 in (1.14 mm)

Color Ebony Black

Interface/ConnectionConnectionIntegrated directly into head unit.PowerVoltage (typical)5 VDC +/- 10%, 50mV ripple max

Current consumption (typical) 40mA max

Drivers Windows native, OPOS, JPOS

Operating Systems Compatibility Windows

Windows 10 IoT Enterprise for Retail (64-bit)*,***

Windows 10 Pro (64-bit)*,***

Temperature Range Operational 0° C to 55° C

Relative Humidity 90% (non-condensing)

Reliability Operating Life 1,000,000 card swipes minimum

Agency Certifications FCC, CE, USB-IF

Country of Origin Taiwan



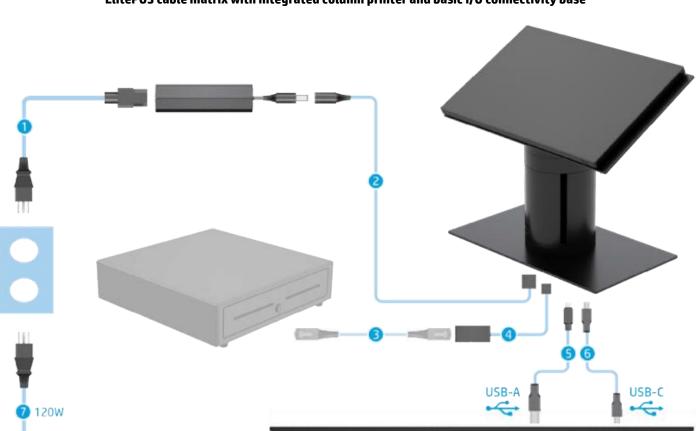
^{*} Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See http://www.microsoft.com

^{**} Not all features are available in all editions of Windows. This system may require upgraded and/or separately purchased hardware to take full advantage of Windows functionality. See http://www.microsoft.com.

^{***} Full support on all x86-based Windows, NO current support drivers for ARM processor platforms.

^{****} The MSR designed into the ElitePOS terminal has an optional encryption functionality. HP has partnered with IDTECH Products to perform key injection services remotley. For more information about their service, contact the IDTECH Product sales team at Sales@idtechproducts.com.

Cable Routing Configurations



ElitePOS cable matrix with integrated column printer and basic I/O connectivity base

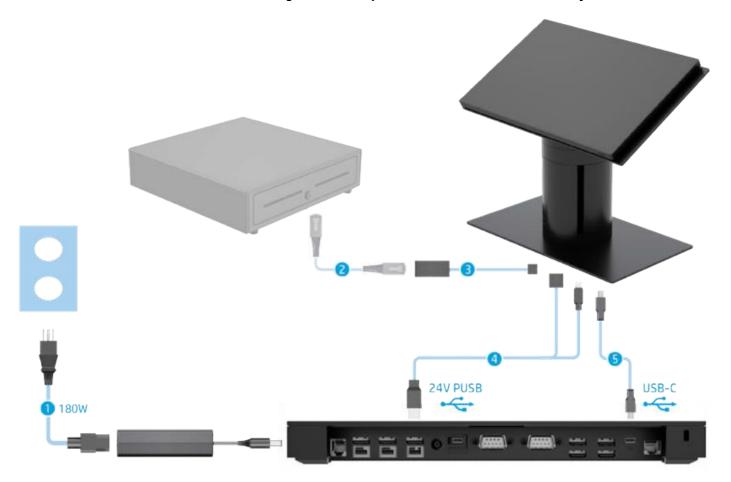
Cables

- 1. Column printer power adapter cord
- 2. Column printer power cable
- 3. Cash drawer cable (purchased separately with cash drawer)
- 4. Column printer cash drawer cable

- 5. I/O connectivity base mini USB Type-B to USB Type-A data cable
- 6. I/O connectivity base USB Type-C cable
- 7. I/O connectivity base 120 W power adapter cord

Cable Routing Configurations

ElitePOS cable matrix with integrated column printer and advanced I/O connectivity base

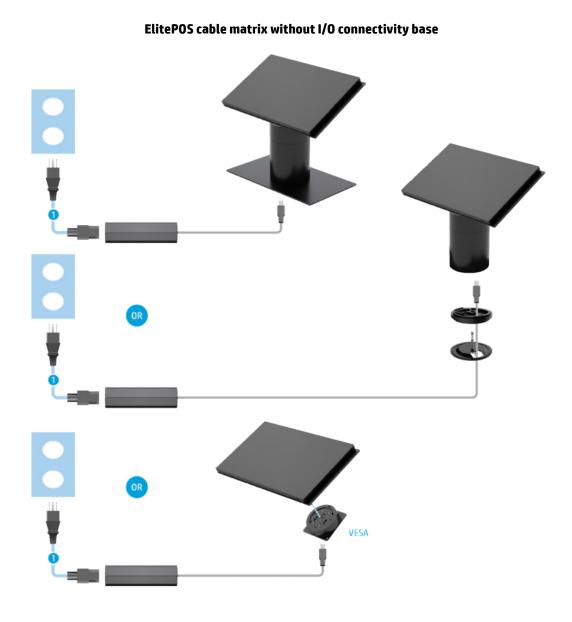


Cables

- 1. I/O connectivity base 180 W power adapter cord
- Cash drawer cable (purchased separately with cash drawer)
- 3. Column printer cash drawer cable

- 4. Column printer 24 V PUSB power and data "Y" cable
- 5. I/O connectivity base USB Type-C cable

Cable Routing Configurations

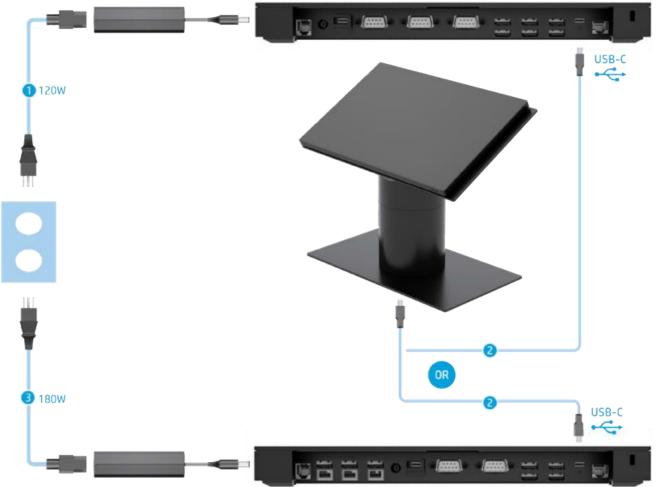


Cables

1. Power adapter cord

Cable Routing Configurations

ElitePOS cable matrix with I/O connectivity base and without printer



Cables

- Basic I/O connectivity base 120 W AC power adapter cord
- 2. I/O connectivity base USB Type-C cable
- 3. Advanced I/O connectivity base 180 W AC power adapter cord

Cable Routing Configurations

Bush-A USB-C

ElitePOS cable matrix with basic I/O connectivity base and standalone printer

Cables

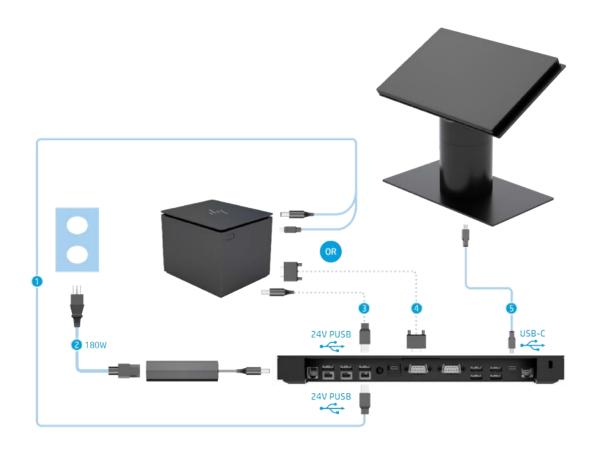
- 1. Printer power adapter cord
- 2. Basic I/O connectivity base 120 W AC power adapter cord
- 3. Printer serial data cable

- 4. Printer USB Type-A data cable
- 5. Basic I/O connectivity base USB Type-C cable

IMPORTANT: Connect either the serial data cable (3) or the USB Type-A data cable (4) between the I/O connectivity base and the printer. Do not connect both.

Cable Routing Configurations

ElitePOS cable matrix with advanced I/O connectivity base and standalone printer



Cables

- 1. Printer 24 V PUSB power and data "Y" cable
- Advanced I/O connectivity base 180 W AC power adapter cord
- 3. Printer 24 V PUSB power cable

- 4. Printer serial data cable
- 5. Advanced I/O connectivity base USB Type-C cable

IMPORTANT: Connect either the 24 V PUSB power and data "Y" cable (1) or the 24 V PUSB power cable (3) and serial data cable (4) between the I/O connectivity base and the printer. Do not connect both.

ElitePOS Accessories

Connectivity Bases	Part Number
HP ElitePOS Advanced I/O Connectivity Base*	1UN12AA
HP ElitePOS Basic I/O Connectivity Base	1UN11AA
Printers	
HP ElitePOS Serial USB Thermal Printer	1RL96AA
HP Hybrid POS Printer with MICR	FK184AA
HP Hybrid POS Printer with MICR II	X3D36AA
HP Ethernet Network Receipt Printer	M2D54AA
HP PUSB Thermal Receipt Printer	FK224AA
HP Serial USB Thermal Receipt Printer	BM476AA
HP Value PUSB Receipt Printer	F7M67AA
HP Value Serial/USB Receipt Printer II	X3B46AA
Epson H2000 PUSB Printer	K3L29AA
Epson TMT88V PUSB Thermal Receipt Printer	E1Q93AA
Epson TMT88V Serial USB Thermal Receipt Printer	D9Z52AA
Integrated Peripherals	
HP ElitePOS Fingerprint Reader	1RL98AA
HP ElitePOS Top Mount 2x20 CFD	1RL95AA
Customer Facing Displays and Display Options	
HP ElitePOS 10.1in Touch Display*	1XD81AA
HP ElitePOS 10.1in Non-Touch Display*	1XD80AA
Pole Displays	0770444
HP Graphical POS Pole Display	QZ704AA
HP LCD Pole Display	F7A93AA
HP POS Pole Display	FK225AA

^{*}Available November 2017



ElitePOS Accessories

Litter OJ Accessories	
Cable kits for stand alone printer	Part Number
HP ElitePOS Printer USB + Pwr Adpter	1RM02AA
HP ElitePOS Printer Serial + Pwr Adptr	1RM03AA
HP ElitePOS Printer PUSB Y Cable	BM477AA
HP ElitePOS Printer Serial + PUSB Pw only	1RM05AA
Graphics Video Adapters & Cables	
HP Type-C to DisplayPort Adapter	N9K78AA
HP Type-C to HDMI Adapter	N9K77AA
HP Type-C to VGA Adapter (Slice)	N9K76AA
IO Devices, I/O Adapters	
HP USB to Serial Port Adapter (Win7/8/10)	J7B60AA
HP USB Business Slim Keyboard	N3R87AA
HP USB 1000dpi Laser Mouse	QY778AA
HP USB Hardened Mouse	P1N77AA
HP USB Optical 2.9M Mouse	Z3Q64AA
HP POS Keyboard	FK221AA
HP POS Keyboard with MSR	FK218AA
HP PUSB Y Cable	BM477AA
	Doub Noveles
Scanners	Part Number
HP ElitePOS 2D Barcode Scanner	1RL97AA
HP Linear Barcode Scanner II	Z1Z36AA
HP Imaging Barcode Scanner	BW868AA
HP Presentation Barcode Scanner	QY439AA
HP Wireless Barcode Scanner	E6P34AA
Cash Drawers	
HP Flip Top Cash Drawer	BW867AA
HP Heavy Duty Cash Drawer	FK182AA
HP Standard Duty Cash Drawer	QT457AA
HP USB Standard Duty Cash Drawer	E8E45AA
HP Standard Duty Till Insert w/ Lockable Lid	QT458AA
HP Cable Pack for Dual HP Cash Drawers	QT538AA
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Summary of Changes

Date of change:	Version History:		Description of change:
August 16, 2017	From v1 to v2	Changed	Format on sections
August 25, 2017	From v2 to v3	Added	Notes about the Mounting bracket, BIOS support and the MSR, added Packaging Weights
		Changed	Format on sections
September 22, 2017	From v3 to v4	Changed	Page 44: HP ElitePOS PUSB Y Cable part number to BM477AA. Page 66: HP ElitePOS Printer PUSB Y Cable part number to BM477AA



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